

Electron beam evaporation

SAD process

Pulse magnetron sputtering

Applications

Corrosion-resistant coatings	ZnMg, Ti, Al, Cr, Cu, Sn, Zn
Decorative coatings	TiN, Cr, Ti, TiO ₂
Transparent abrasion-resistant coatings	SiO _X , Al ₂ O ₃
Hard coatings	TiN, TiC, a-C, WC, Al ₂ O ₃ , a-C(:H)(:Ti/W)
Insulating coatings	SiO _X , Al ₂ O ₃
Conductive coatings	Al, Cu, Sn, Mo
Brazing and welding layers	Cu, Sn, Si
Photo catalytic layers	TiO ₂
Solar absorption layers	Ti- or Cr based cermets
Conversion layers	SiO _x
High-reflective layers	SiO ₂ , TiO ₂
Special function layers	Al, Cu, Sn

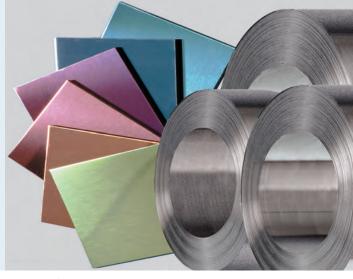
Coating processes

- High-rate electron beam evaporation
- Evaporation of metals, compounds, alloys
- Plasma-activated deposition processes (SAD and HAD)
- Reactive deposition processes
- Pulse magnetron sputtering
- Other PVD processes (e.g. jet evaporation)
- PECVD processes

Equipment

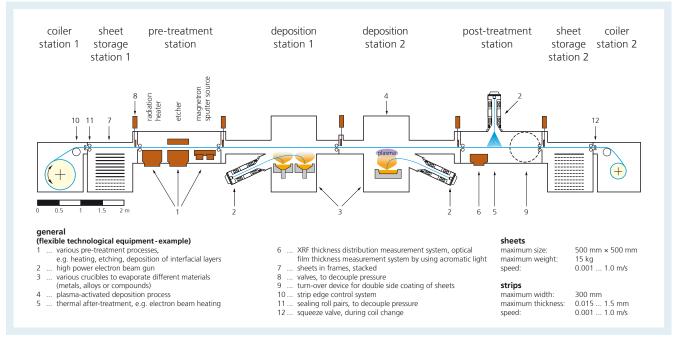
General	modularly built 8-chamber equipment	
General dimensions	length / width / height: 14 m / 2.5 m / 4m	
Coating width	up to 500 mm	
Substrate speed	0.001 1.0 m/s	
Strip dimensions	width up to 300 mm	
	■ thickness 0.015 mm 1.5 mm	
	• weight of coil up to 1000 kg	
Sheet dimensions	size up to 500 mm × 500 mm	
	• weight up to 15 kg	
1st electron beam gun	power maximum 160 kW	
2 nd electron beam gun	power maximum 300 kW	
Additional equipment	heater, power maximum 60 kW	
	different ion etchers, power maximum 30 kW	
	dual magnetron sputter system, power maximum 30 kW	
	power supply for plasma activation, arc current max. 3000 A	
	 magnetic trap for the EB coating of temperature sensitive substrates 	
	turn-over device for double side coating of sheets	
	 XRF thickness distribution measurement system 	
	optical film thickness measurement system by using acromatic light	





Coiler station 1

Coating of metal sheets and strips



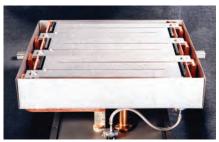
Schematic layout of the MAXI plant



Magnetic field enhanced ion etcher



Post-treatment station



Radiation heater



XRF thickness distrubutuion measurement system



High-power electron beam gun

Contact

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